#### TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

# **TB62715FN**

## 8 BIT SHIFT REGISTER, LATCHES & CONSTANT CURRENT DRIVERS

The TB62715FN is specifically designed for LED and LED DISPLAY constant current drivers.

This constant current output circuits is able to set up external resistor (IOUT =  $2{\sim}150$  mA).

This IC is monolithic integrated circuit designed to be used together with Bi-CMOS process.

The devices consist of 8 bit shift register, latch, AND–GATE & Constant Current Drivers.



#### Weight: 0.14 g (typ.)

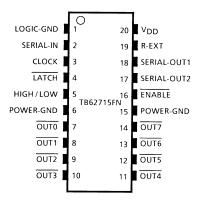
#### **FEATURES**

- Constant Current Output: Can set up all output current with one resistor for 80 to 150 mA.
- Constant Output Current Matching:

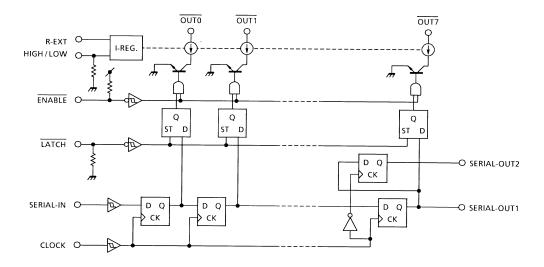
| HIGH / LOW | OUTPUT-GND<br>VOLTAGE | CURRENT<br>MATCHING<br>(BIT) | CURRENT<br>MATCHING<br>(LOT) | OUTPUT<br>CURRENT<br>(MAX.) |  |
|------------|-----------------------|------------------------------|------------------------------|-----------------------------|--|
| "L"        | ≥0.7 V                | ±6.0 %                       | ±15.0 %                      | 2~70 mA                     |  |
| "H"        | ≥1.0 V                | ±6.0 %                       | ±15.0 %                      | 50~150 mA                   |  |

- Maximum Clock Frequency: fCLK = 15 MHz
  - (Cascade Connected Operate, Topr = 25°C)
- 5 V C-MOS Compatible Input
- Package: SSOP20-P-225-0.65A

## **PIN CONNECTION (TOP VIEW)**



## **BLOCK DIAGRAM**



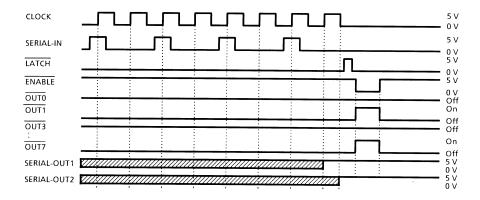
## **TRUTH TABLE**

| CLOCK | LATCH | ENABLE | SERIAL-IN        | OUT0 ··· OUT5 ··· OUT7                  | SERIAL-OUT       |
|-------|-------|--------|------------------|---|------------------|
| UP    | Н     | L      | D <sub>n</sub>   | $D_n \cdots D_{n-5} \cdots D_{n-7}$     | D <sub>n-7</sub> |
| UP    | L     | L      | D <sub>n+1</sub> | No Change                               | D <sub>n-6</sub> |
| UP    | Н     | L      | D <sub>n+2</sub> | $D_{n+2}\cdots D_{n-3}\cdots D_{n-5}$   | D <sub>n-5</sub> |
| DOWN  | Х     | L      | D <sub>n+3</sub> | $D_{n+2} \cdots D_{n-3} \cdots D_{n-5}$ | D <sub>n-5</sub> |
| DOWN  | Х     | Н      | D <sub>n+3</sub> | Off                                     | D <sub>n-5</sub> |

Note:  $\overline{OUT0 \sim 7}$  = on in case of  $D_n$  = H level and  $\overline{OUT0 \sim 7}$  = off in case of  $D_n$  = level.

A resistor is connected with R-EXT and GND accompanied with outside, and it is necessary that a correct power supply voltage is supplied.

## **TIMING DIAGRAM**



Note: Latches are level sensitive, not rising edge sensitive and not syncronus CLOCK.

Input of LATCH –terminal to H Level, data passes latches, and input to L level, data hold latches.

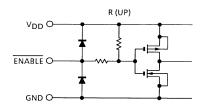
Input of ENABLE -terminal to H level, all output (OUT0 ~ 7) do off.

## **TERMINAL DISCRIPTION**

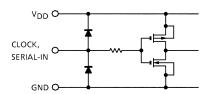
| PIN No.        | PIN NAME        | FUNCTION  |
|----------------|-----------------|---|
| 5              | HIGH / LOW      | It is the terminal which does switching for the big current / low current.  |
| 6, 15          | POWER-GND       | GND terminal for current output.  |
| 1              | LOGIC-GND       | GND terminal for control logic.   |
| 2              | SERIAL-IN       | Input terminal of a serial-data for shift-register.   |
| 3              | CLOCK           | Input terminal of a clock for data shift to up-edge.  |
| 4              | LATCH           | Input terminal of a data strobe. Latches passes data with "H" level input of LATCH-terminal, and hold data with "L" level input.      |
| 7~10,<br>11~14 | OUT0~7          | Output terminals.   |
| 16             | ENABLE          | Input terminal of output enable. All outputs (OUT0~7) do off with "H" level input of ENABLE-terminal, and do on with "L" level input. |
| 18             | SERIAL-OUT1     | Output terminal of serial-data  |
| 17             | SERIAL-OUT2     | Output terminal of a serial-data for next SERIAL-IN terminal.   |
| 19             | R-EXT           | Input terminal of connects with a resister for to set up all output current.  |
| 20             | V <sub>DD</sub> | 5 V Supply voltage terminal.  |

## **EQUIVALENT CIRCUIT OF INPUTS AND OUTPUTS**

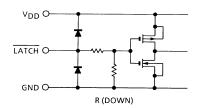
## 1. **ENABLE** terminal



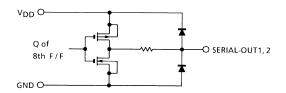
## 3. CLOCK, SERIAL-IN terminal



## 2. LATCH terminal



## 4. SERIAL-OUT terminal



## **ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)**

| CHARACTERISTIC        | SYMBOL                  | RATING                              | UNIT     |  |
|-----------------------|-------------------------|-------------------------------------|----------|--|
| Supply Voltage        | $V_{DD}$                | 0 ~ +7.0                            | V        |  |
| Input Voltage         | V <sub>IN</sub>         | -0.4 ~ V <sub>DD</sub> +0.4         | V        |  |
| Output Current        | I                       | +150 (HIGH / LOW = "H")             | mA / ob  |  |
| Output Current        | lout                    | +70 (HIGH / LOW = "L")              | mA / ch  |  |
| Output Voltage        | V <sub>OUT</sub>        | -0.5 ~ +17.0                        | V        |  |
| Clock Frequency       | f <sub>CLK</sub>        | 15                                  | MHz      |  |
| GND Terminal Current  | I <sub>GND</sub>        | 1200                                | mA       |  |
| Davier Dissination    | P <sub>D1</sub>         | FN-type : 0.71 (FREE AIR, Ta = 25°C | W        |  |
| Power Dissipation     | P <sub>D2</sub>         | FN-type : 0.96 (ON PCB, Ta = 25°C)  | VV       |  |
| Thermal Resistance    | R <sub>th (j-a) 1</sub> | 175 (FREE AIR)                      | °C / \\/ |  |
| memai Resistance      | R <sub>th (j-a) 2</sub> | 130 (ON PCB)                        | °C/W     |  |
| Operating Temperature | T <sub>opr</sub>        | -40 ~ +85                           | °C       |  |
| Storage Temperature   | T <sub>stg</sub>        | -55 ~ +150                          | °C       |  |

Note: FN type: Ambient temperature delated above 25°C in the proportion of 7.69 mW / °C Condition = On PCB ( $50 \times 50 \times 1.6$  mm Cu = 40%)

## RECOMMENDED OPERATING CONDITION (Ta = 25°C unless otherwise noted)

| CHARACTERISTIC        | SYMBOL                    | CONDITION   | MIN                    | TYP. | MAX                    | UNIT |  |  |
|-----------------------|---------------------------|---|------------------------|------|------------------------|------|--|--|
| Supply Voltage        | $V_{DD}$                  |   | 4.5                    | 5.0  | 5.5                    | V    |  |  |
| Output Voltage        | VOUT                      |   | _                      | _    | 15.0                   | V    |  |  |
|                       | I <sub>OUT1</sub>         | DC 1 circuit<br>(HIGH / LOW = "H")                | 50                     | _    | 130                    | mA / |  |  |
| Output Current        | I <sub>OUT2</sub>         | DC 1 circuit<br>(HIGH / LOW = "L")                | 2                      | _    | 60                     | ch   |  |  |
|                       | Гон                       | SERIAL-OUT1, 2                                    | _                      | _    | -1.0                   | mA   |  |  |
|                       | I <sub>OL</sub>           | SERIAL-OUT1, 2                                    | _                      | _    | 1.0                    |      |  |  |
| Input Voltage         | VIH                       |   | 0.7<br>V <sub>DD</sub> | _    | V <sub>DD</sub> + 0.3  | V    |  |  |
| Input Voltage         | V <sub>IL</sub>           |   |                        | _    | 0.3<br>V <sub>DD</sub> |      |  |  |
| LATCH Pulse Width     | t <sub>w</sub> <u>LAT</u> |   | 100                    | _    | _                      | ns   |  |  |
| CLOCK Pulse Width     | tw CLK                    | VDD = 4.5~5.5 V                                   | 50                     | _    | _                      | ns   |  |  |
| ENABLE Pulse Width    | tw EN                     | - VBB - 4.3 3.3 V                                 | 1000                   | _    | _                      | ns   |  |  |
| Set-up Time for DATA  | t <sub>setup (D)</sub>    |   | 60                     | _    | _                      | ns   |  |  |
| Hold Time for DATA    | thold (D)                 |   | 20                     | _    | _                      | ns   |  |  |
| Set-up Time for LATCH | t <sub>setup (L)</sub>    |   | 100                    | _    | _                      | ns   |  |  |
| Hold Time for LATCH   | t <sub>hold (L)</sub>     |   | 60                     | _    | _                      | ns   |  |  |
| Clock Frequency       | f <sub>CLK</sub>          | V <sub>DD</sub> = 4.5~5.5 V,<br>Cascade Operation | 10.0                   | _    | _                      | MHz  |  |  |
| Power Dissipation     | PD                        | Ta = 85°C (FN-type On PCB)                        | _                      | _    | 0.50                   | W    |  |  |

## ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

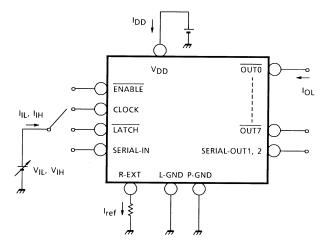
| CHARACTERISTIC    |              | SYMBOL                  | TEST<br>CIR-<br>CUIT | cc  | ONDITION   | MIN                    | TYP.                    | MAX             | UNIT  |
|-------------------|--------------|-------------------------|----------------------|---|--|------------------------|-------------------------|-----------------|-------|
| Input Voltage     | "H" Level    | V <sub>IH</sub>         | 1                    | _   |  | 0.7<br>V <sub>DD</sub> | _                       | V <sub>DD</sub> | V     |
| input voltage     | "L" Level    | V <sub>IL</sub>         | '                    |   |  | GND                    | GND $ 0.3 \atop V_{DD}$ |                 |       |
| Output Leakage C  | Current      | I <sub>OH</sub>         | 1                    | V <sub>OH</sub> = 15.0 \                            | <b>\</b>   |                        | _                       | 10              | μA    |
| Output Voltage    | SERIAL-OUT   | V <sub>OH</sub>         | 1                    | I <sub>OL</sub> = -1.0 m                            | Α  | _                      | _                       | 0.4             | V     |
| Output Voltage    | 1, 2         | V <sub>OL</sub>         | ] '                  | I <sub>OL</sub> = +1.0 m                            | Α  | 4.6                    | _                       | _               |       |
| Output Current 1  |              | I <sub>OL1</sub>        | 1                    | ., 0.7.,  | $E = 0.7 \text{ V}$ $R_{EXT} = 520 \Omega,$ $HIGH / LOW = "L"$ | 31.7                   | 37.5                    | 43.1            | mA    |
|                   | Current Skew | dl <sub>OL1</sub>       | 1                    | VCE - 0.7 V   |  | _                      | ±1.5                    | ±6.0            | %     |
| Output Current 2  |              | I <sub>OL2</sub>        | 1                    | V <sub>CE</sub> = 1.0 V                             | R <sub>EXT</sub> = 160 Ω,<br>HIGH / LOW = "H"                  | 104.0                  | 123.0                   | 141.4           | mA    |
|                   | Current Skew | dl <sub>OL2</sub>       |                      |   |  | _                      | ±1.5                    | ±6.0            | %     |
| Supply Voltage Re | egulation    | % / V <sub>DD</sub>     | 1                    | Ta = −40~ +85°C                                     |  | _                      | +1.5                    | +5.0            | % / V |
| Pull-up Resistor  |              | R <sub>IN (up)</sub>    | 1                    |   |  | 100                    | 200                     | 400             | kΩ    |
| Pull-down Resisto | or           | R <sub>IN (down)</sub>  | 1                    |   |  |                        | 200                     | 400             | KΩ    |
|                   |              | I <sub>DD (off) 1</sub> |                      | R <sub>EXT</sub> = OPE                              | N $\overline{OUT0 \sim 7} = off$                               | _                      | 1.0                     | 2.0             |       |
| Supply Current    | "OFF"        | I <sub>DD (off) 2</sub> |                      | $R_{EXT} = 260 \Omega \overline{OUT0 \sim 7} = off$ |  | _                      | 10.0                    | 15.0            |       |
|                   |              | I <sub>DD</sub> (off) 3 | 1                    | R <sub>EXT</sub> = 160                              | $\Omega$ $\overline{OUT0 \sim 7} = off$                        | _                      | 16.0                    | 21.0            | mA    |
|                   | "ON"         | I <sub>DD (on) 1</sub>  |                      | R <sub>EXT</sub> = 260                              | $\Omega$ $\overline{OUT0 \sim 7} = on$                         | _                      | 23.1                    | 40.5            |       |
|                   |              | I <sub>DD (on) 2</sub>  |                      | R <sub>EXT</sub> = 160                              | $\Omega$ $\overline{OUT0 \sim 7} = on$                         | _                      | 33.0                    | 62.1            |       |

## **SWITCHING CHARACTERISTICS** (Ta = 25°C unless otherwise noted)

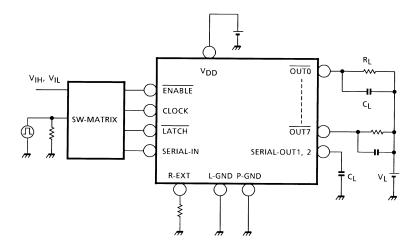
| CHARACTERISTIC            |               | SYMBOL                     | TEST<br>CIR-<br>CUIT | CONDITION  | MIN | TYP. | MAX  | UNIT |   |  |   |   |   |  |   |   |    |
|---------------------------|---------------|----------------------------|----------------------|--|-----|------|------|------|---|--|---|---|---|--|---|---|----|
|                           | SIN- OUTn     |                            | 2                    |  | _   | 500  | 1000 | ns   |   |  |   |   |   |  |   |   |    |
| Propagation<br>Delay Time | LATCH - OUTn  | <b></b>                    |                      |  | _   | 500  | 1000 |      |   |  |   |   |   |  |   |   |    |
| ("L" To "H")              | ENABLE - OUTn | t <sub>pLH</sub>           | 2                    |  | _   | 500  | 1000 |      |   |  |   |   |   |  |   |   |    |
|                           | CLK-SOUTn     |                            |                      |  | _   | 30   | 70   |      |   |  |   |   |   |  |   |   |    |
|                           | SIN- OUTn     |                            |                      |  | _   | 500  | 1000 | - ns |   |  |   |   |   |  |   |   |    |
| Propagation<br>Delay Time | LATCH - OUTn  | 4                          | 2                    | V <sub>DD</sub> = 5.0 V  | _   | 500  | 1000 |      |   |  |   |   |   |  |   |   |    |
| ("H" To "L")              | ENABLE - OUTn | t <sub>pHL</sub>           | - 2                  | V <sub>CE</sub> = 1.0 V  | _   | 500  | 1000 |      |   |  |   |   |   |  |   |   |    |
|                           | CLK-SOUTn     |                            |                      | $\begin{aligned} &V_{IH} = V_{DD}, \\ &V_{IL} = GND \\ &R_{EXT} = 260 \ \Omega, \\ &R_{L} = 32 \ \Omega \\ &I_{OUT} = 125 \ mA, \\ &C_{L} = 10.5 \ pF \\ &t_{or}  : 10\% \ to \ 90\% \\ &t_{or}  : 90\% \ to \ 10\% \end{aligned}$ | _   | 30   | 70   |      |   |  |   |   |   |  |   |   |    |
| Pulse Width               | CLK           | tw CLK, / CLK              |                      |  | _   | 20   | 30   | ns   |   |  |   |   |   |  |   |   |    |
| Fulse Width               | LATCH         | $t_W \overline{LAT}$ ,/LAT |                      |  | _   | 10   | 25   | 115  |   |  |   |   |   |  |   |   |    |
| Set-Up Time for           | L-H           | t <sub>setupLAT</sub>      | 2                    |  | _   | 25   | 50   | ns   |   |  |   |   |   |  |   |   |    |
| LATCH / SIN               | H-L           | & SIN                      |                      | t <sub>pl H</sub> : 50% to 10%   | _   | 25   | 50   | 115  |   |  |   |   |   |  |   |   |    |
| Hold Time for             | L-H           | thold                      | 2                    | t <sub>pHL</sub> : 50% to 90%  | _   | 0    | 15   |      |   |  |   |   |   |  |   |   |    |
| LATCH / SIN               | H-L           | LAT / SIN                  |                      | 2  | _   | ۷    | ۷    | 2    | ۷ |  | 2 | 2 | 2 |  | _ | 0 | 15 |
| Maximum CLOCK Rise Time   |               | t <sub>r</sub>             | 2                    |  | _   | _    | 10   | μs   |   |  |   |   |   |  |   |   |    |
| Maximum CLOCK Fall Time   |               | t <sub>f</sub>             | 2                    |  | _   | _    | 10   | μs   |   |  |   |   |   |  |   |   |    |
| Output Rise Time          |               | t <sub>or</sub>            | 2                    |  | 300 | 600  | 1000 | ns   |   |  |   |   |   |  |   |   |    |
| Output Fall Time          |               | t <sub>of</sub>            | 2                    |  | 300 | 600  | 1000 | ns   |   |  |   |   |   |  |   |   |    |

## **TEST CIRCUIT**

## **DC** characteristic



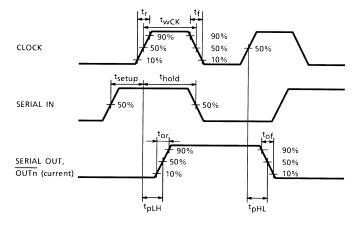
## **AC** characteristic



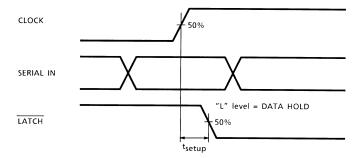
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## **TIMING WAVEFORM**

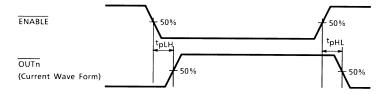
## 1. CLOCK-SERIAL OUT, OUTn

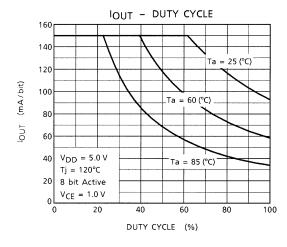


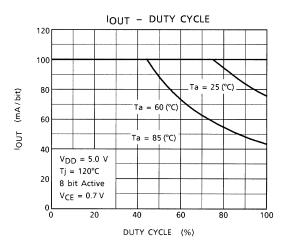
## 2. CLOCK-LATCH

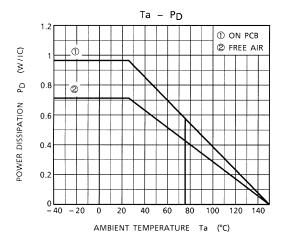


## 3. ENABLE -OUTn

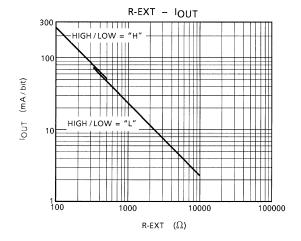


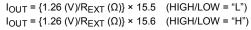


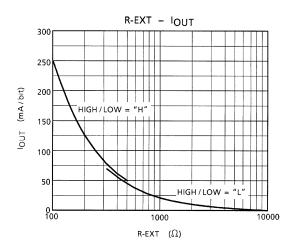




## LED DRIVER TB6270X SERIES APPLICATION NOTE







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## TOTAL SUPPLY VOLTAGE (VLED)

This device can operate 0.7 V (VO).

When a higher voltage is input to the device, the excess voltage is consumed inside the device, that leads to power dissipation.

In order to minimize power dissipation and loss, we would like to recommend to set the total supply voltage as shown below,

VLED (total supply voltage) = VCE (Tr V<sub>sat</sub>) + V<sub>f</sub> (LED Forward voltage) + V<sub>O</sub> (IC supply voltage)

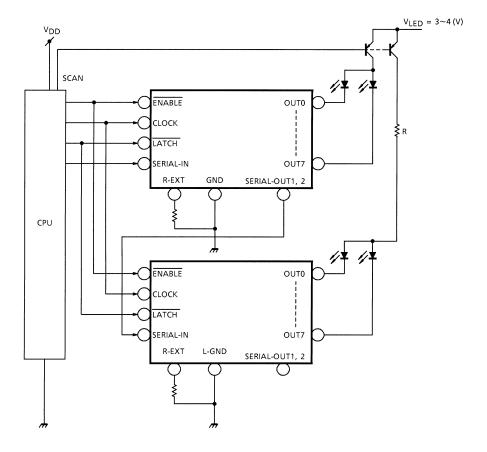
When the total supply is too high considering the power dissipation of this device, an additional R can decrease the supply voltage.

$$R \,=\, \frac{V_{LED} - V_{f} \, (LED) - V_{O} \, (Min.)}{I_{O} \, (Max.) \times \, BIT \, \, (Max.)}$$

#### PATTERN LAYOUT

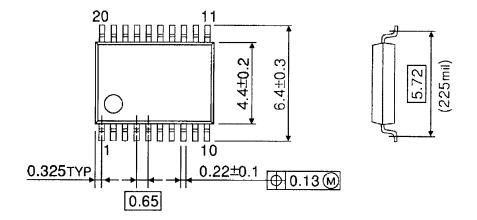
This device owns only one ground pin that means signal ground pin power ground pin are common. If ground pattern layout contains large inductance and impedance, and the voltage between ground and  $\overline{\text{LATCH}}$ , CLOCK terminals exceeds 2.5 V by switching noise in operation, this device may miss-operated. So we would like you to pay attention to pattern layout to minimize inductance.

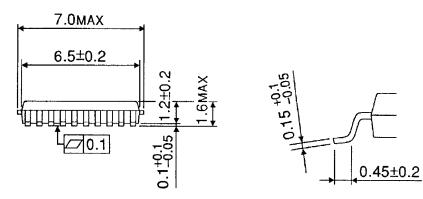
#### APPLICATION CIRCUIT



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## **Package Dimensions**





Weight: 0.14 g (typ.)

#### **Notes on Contents**

## 1. Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

#### 2. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

#### 3. Timing Charts

Timing charts may be simplified for explanatory purposes.

## 4. Application Circuits

The application circuits shown in this document are provided for reference purposes only.

Thorough evaluation is required, especially at the mass production design stage.

To shiba does not grant any license to any industrial property rights by providing these examples of application circuits.

#### 5. Test Circuits

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

## IC Usage Considerations

#### Notes on Handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
  Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.

  Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly. Make sure that the positive and negative terminals of power supplies are connected properly. Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion. In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.

  If there is a large amount of leakage current such as input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure can cause smoke or ignition. (The over current can cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection type IC that inputs output DC voltage to a speaker directly.

#### Points to Remember on Handling of ICs

(1) Heat Radiation Design

In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature (Tj) at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into considerate the effect of IC heat radiation with peripheral components.

(2) Back-EMF

When a motor rotates in the reverse direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

#### **RESTRICTIONS ON PRODUCT USE**

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- The information contained herein is subject to change without notice. 021023\_D
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